



General Description

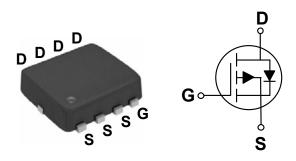
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV _{DSS}	R _{DS(ON)}	Ι _D
-30 V	15 mΩ(typ)	-30 A

Features

- $R_{DS(ON)}$ =15m Ω @ V_{GS} = -10V
- · Fast Switching
- · Green Device Available
- Suit for -4.5V Gate Drive Applications

PPAK3X3 Pin Configuration



Applications

- MB / VGA / V_{CORE}
- · POL Applications
- · LED Application
- · Load Switch

Absolute Maximum Ratings T _c =25°C unless otherwise noted							
Symbol	Parameter	Rating	Units				
V _{DS}	Drain-Source Voltage	-30	V				
V_{GS}	Gate-Source Voltage	±20	V				
	Drain Current - Continuous (T _C =25°C)	-30	Α				
I _D	Drain Current - Continuous (T _C =100°C)	-19	Α				
	Drain Current - Continuous (T _A =25°C)	-8	Α				
I _{DM}	Drain Current - Pulsed (NOTE 1)	-120	Α				
P _D	Power Dissipation (T _C =25°C)	23	W				
T_J	Operating Junction Temperature Range	-50 to 150	°C				
T _{STG}	Storage Temperature Range	-50 to 150	°C				
Marking Code		PC015					

Thermal Characteristics					
Symbol	Parameter	Тур.	Max	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		62	°C/W	
$R_{ heta JC}$	Thermal Resistance Junction to Case		5.4	°C/W	





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0V , I_D = -250uA	-30			V
I _{DSS}	Drain-Source Leakage Current	V_{DS} = -30V , V_{GS} = 0V , T_{J} =25 $^{\circ}$ C			-1	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = ±20V , V_{DS} = 0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} = -10V , I_D = -8A		15	mΩ	
	Static Dialii-Source Off-Nesistance	V_{GS} = -4.5V , I_D = -6A		25		11152
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=-250uA$	-1.2		-2.5	V
gfs	Forward Transconductance	V_{DS} = -10V , I_{D} = -8A		10.5		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge (NOTE 2 \ 3)	V _{DS} = -15V , V _{GS} = -4.5V ,	-	14.6		
Q_gs	Gate-Source Charge (NOTE 2 \ 3)	V _{DS} 15V , V _{GS} 4.5V , I _D = -8A		4.1		nC
Q_{gd}	Gate-Drain Charge (NOTE 2 \ 3)	1.b 3,1	-	6.3		
$T_{d(on)}$	Turn-On Delay Time (NOTE 2 \ 3)		-	9		
T _r	Rise Time (NOTE 2 \cdot 3)	V_{DD} = -15V , V_{GS} = -10V , R_{G} = 6 Ω , I_{D} = -1A	-	21.8		nS
$T_{d(off)}$	Turn-Off Delay Time (NOTE 2 · 3)			59.8		110
T_f	Fall Time (NOTE 2 \ 3)			14.4		
C _{iss}	Input Capacitance			1730		
C _{oss}	Output Capacitance	V_{DS} = -15V , V_{GS} = 0V , F= 1MHz		180		pF
C_{rss}	Reverse Transfer Capacitance			125		

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G = V _D = 0V,Force Current		-	-30	Α
I _{SM}	Pulsed Source Current				-120	Α
V _{SD}	Diode Forward Voltage	V_{GS} = 0V , I_{S} = -1A , T_{J} =25 $^{\circ}$ C			-1	V

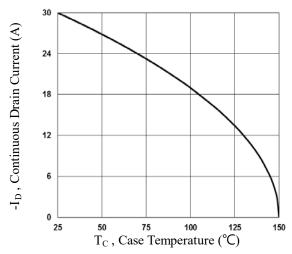
NOTES:

- ${\it 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.}$
- 2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 3. Essentially independent of operating temperature.

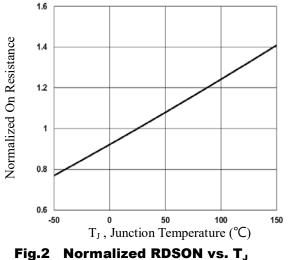




Characteristics Curves



Continuous Drain Current vs. T_c



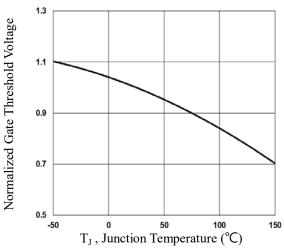


Fig.3 Normalized V_{th} vs. T_J

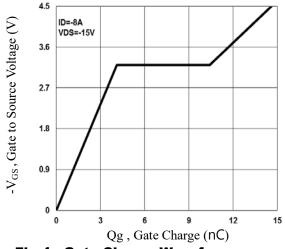


Fig.4 Gate Charge Waveform

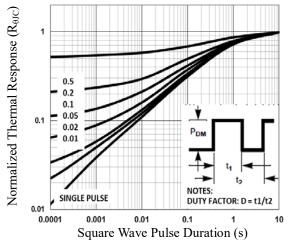


Fig.5 Normalized Transient Impedance

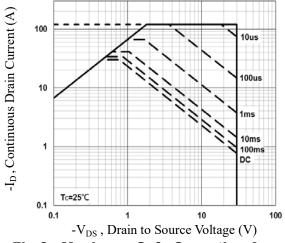
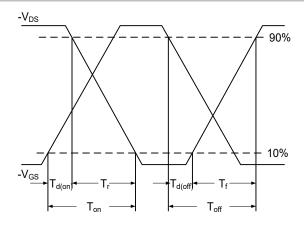


Fig.6 Maximum Safe Operation Area





Characteristics Curves





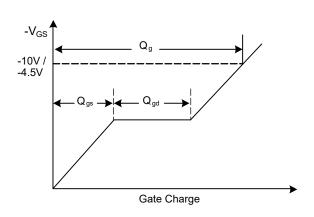
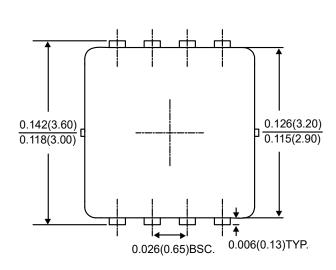
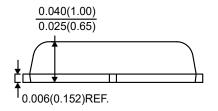
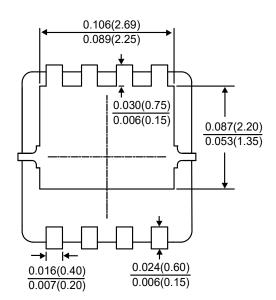


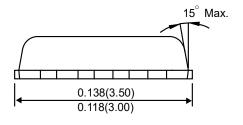
Fig.8 Gate Charge Waveform

Package Outline Dimensions









PPAK3X3

Dimensions in inches and (millimeters)





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